

SN54192, SN54193, SN54LS192, SN54LS193, SN74192, SN74193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

SDLS074 - DECEMBER 1972 - REVISED MARCH 1988

- Cascading Circuitry Provided Internally
- Synchronous Operation
- Individual Preset to Each Flip-Flop
- Fully Independent Clear Input

SN54192, SN54193, SN54LS192,
SN54LS193 . . . J OR W PACKAGE
SN74192, SN74193 . . . N PACKAGE
SN74LS192, SN74LS193 . . . D OR N PACKAGE

| TYPES | TYPICAL MAXIMUM COUNT FREQUENCY | TYPICAL POWER DISSIPATION |
|----------------|------------------------------------|------------------------------|
| '192, '193 | 32 MHz | 325 mW |
| 'LS192, 'LS193 | 32 MHz | 95 mW |

(TOP VIEW)



description

These monolithic circuits are synchronous reversible (up/down) counters having a complexity of 55 equivalent gates. The '192 and 'LS192 circuits are BCD counters and the '193 and 'LS193 are 4-bit binary counters. Synchronous operation is provided by having all flip-flops clocked simultaneously so that the outputs change coincidentally with each other when so instructed by the steering logic. This mode of operation eliminates the output counting spikes which are normally associated with asynchronous (ripple-clock) counters.

The outputs of the four master-slave flip-flops are triggered by a low-to-high-level transition of either count (clock) input. The direction of counting is determined by which count input is pulsed while the other count input is high.

All four counters are fully programmable; that is, each output may be preset to either level by entering the desired data at the data inputs while the load input is low. The output will change to agree with the data inputs independently of the count pulses. This feature allows the counters to be used as modulo-N dividers by simply modifying the count length with the preset inputs.

A clear input has been provided which forces all outputs to the low level when a high level is applied. The clear function is independent of the count and load inputs. The clear, count, and load inputs are buffered to lower the drive requirements. This reduces the number of clock drivers, etc., required for long words.

These counters were designed to be cascaded without the need for external circuitry. Both borrow and carry outputs are available to cascade both the up- and down-counting functions. The borrow output produces a pulse equal in width to the count-down input when the counter underflows. Similarly, the carry output produces a pulse equal in width to the count-up input when an overflow condition exists. The counters can then be easily cascaded by feeding the borrow and carry outputs to the count-down and count-up inputs respectively of the succeeding counter.

SN54LS192, SN54LS193 . . . FK PACKAGE
(TOP VIEW)



NC - No internal connection

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| | SN54' | SN54LS' | SN74' | SN74LS' | UNIT |
|---------------------------------------|------------|---------|------------|---------|------|
| Supply voltage, V_{CC} (see Note 1) | 7 | 7 | 7 | 7 | V |
| Input voltage | 5.5 | 7 | 5.5 | 7 | V |
| Operating free-air temperature range | -55 to 125 | | 0 to 70 | | °C |
| Storage temperature range | -65 to 150 | | -65 to 150 | | °C |

NOTE 1: Voltage values are with respect to network ground terminal.

PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

 **TEXAS
INSTRUMENTS**

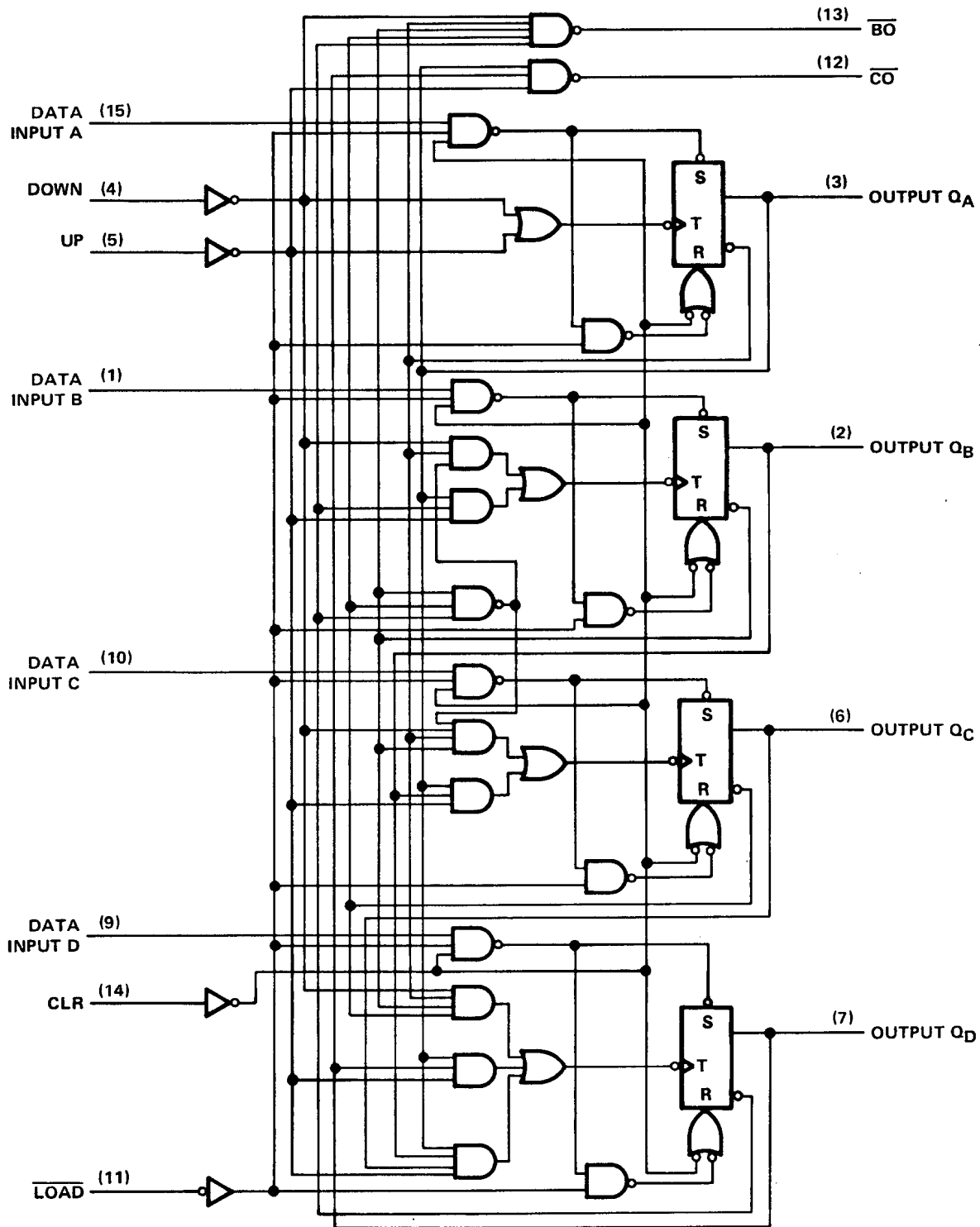
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SN54192, SN54LS192, SN74192, SN74LS192 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

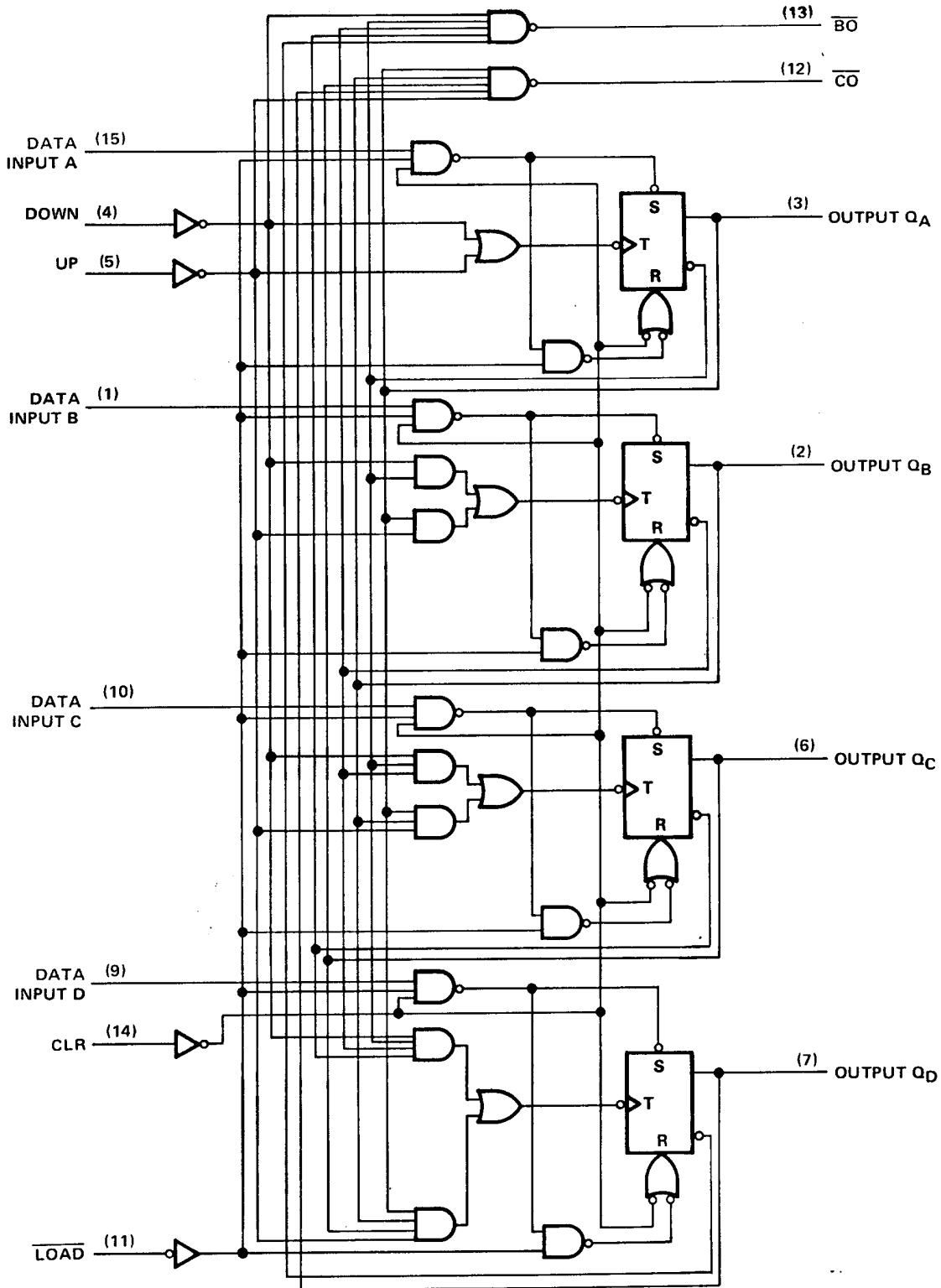


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SN54193, SN54LS193, SN74193, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.



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**SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)**

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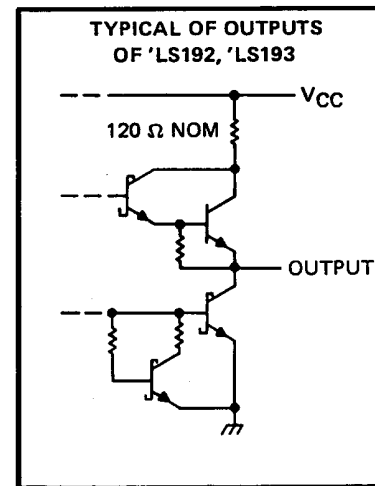
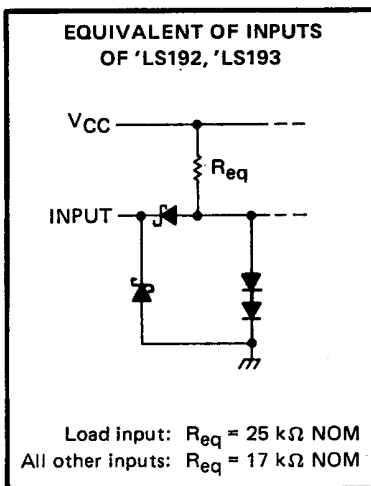
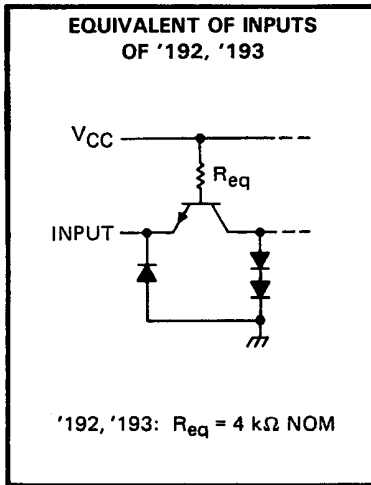
logic symbols†



†These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.

schematics of inputs and outputs



SN54192, SN54LS192, SN74192, SN74LS192 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

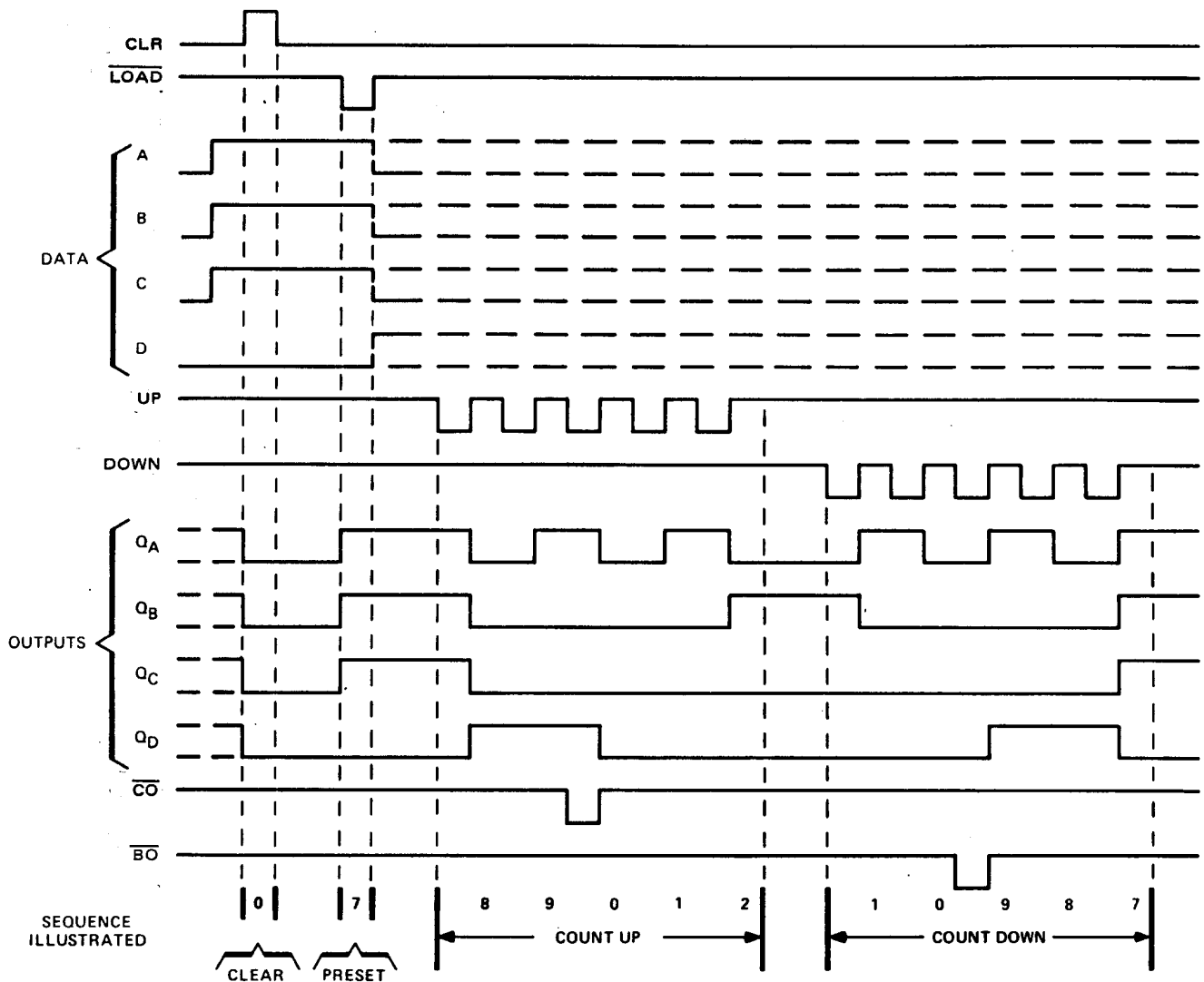
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'192, 'LS192 DECADE COUNTERS

typical clear, load, and count sequences

Illustrated below is the following sequence:

1. Clear outputs to zero.
2. Load (preset) to BCD seven.
3. Count up to eight, nine, carry, zero, one, and two.
4. Count down to one, zero, borrow, nine, eight, and seven.



NOTES: A. Clear overrides load, data, and count inputs.

B. When counting up, count-down input must be high; when counting down, count-up input must be high.



SN54193, SN54LS193, SN74193, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

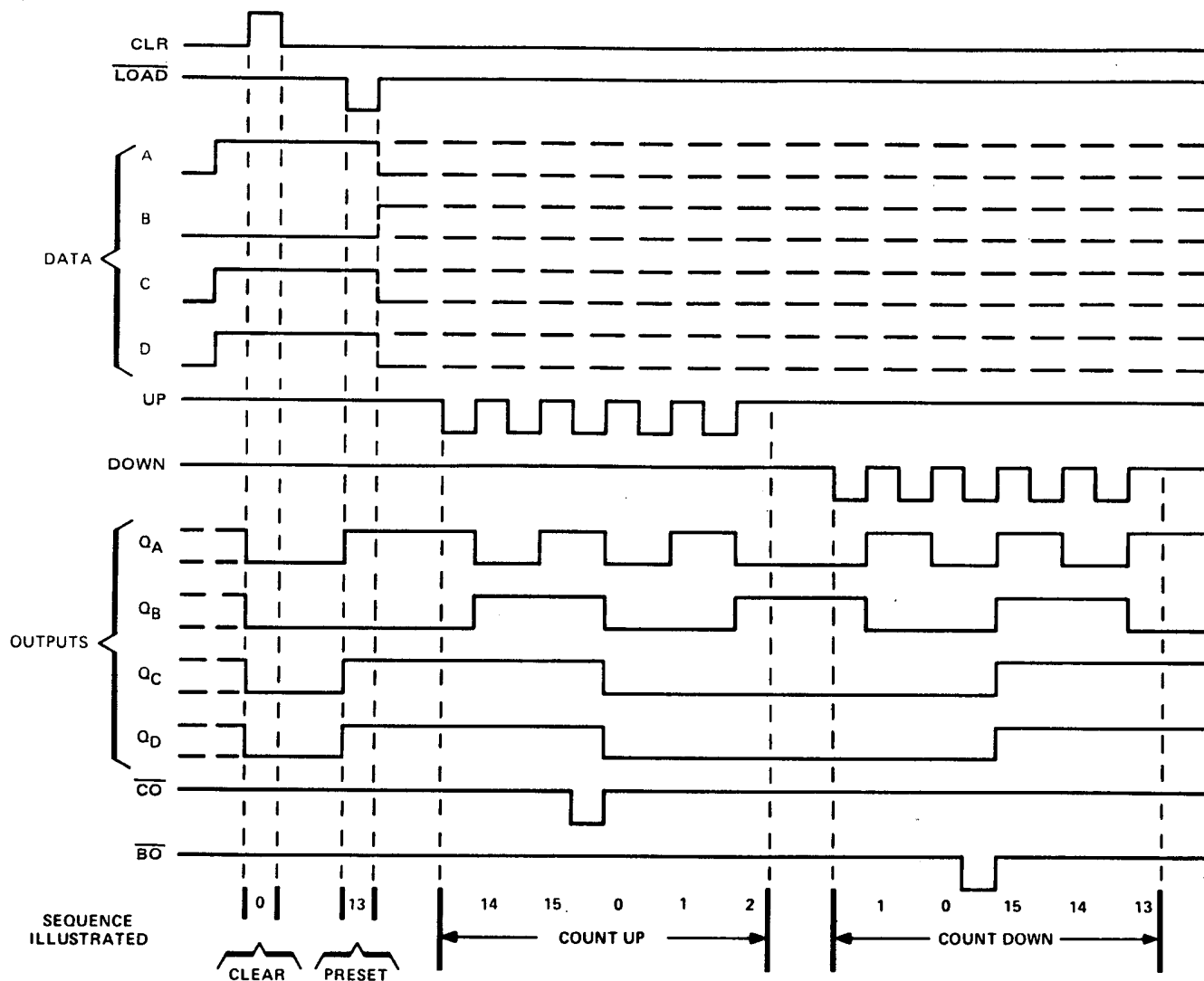
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'193, 'LS193 BINARY COUNTERS

typical clear, load, and count sequences

Illustrated below is the following sequence:

1. Clear outputs to zero.
2. Load (preset) to binary thirteen.
3. Count up to fourteen, fifteen, carry, zero, one, and two.
4. Count down to one, zero, borrow, fifteen, fourteen, and thirteen.



- NOTES: A. Clear overrides load, data, and count inputs.
 B. When counting up, count-down input must be high; when counting down, count-up input must be high.



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SN54192, SN54193, SN74192, SN74193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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recommended operating conditions

| | | SN54192 SN54193 | | | SN74192 SN74193 | | | UNIT |
|--------------------|---------------------------------|--------------------|-----|------|--------------------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| I _{OH} | High-level output current | | | -0.4 | | | -0.4 | mA |
| I _{OL} | Low-level output current | | | 16 | | | 16 | mA |
| f _{clock} | Clock frequency | 0 | | 25 | 0 | | 25 | MHz |
| t _w | Width of any input pulse | 20 | | | 20 | | | ns |
| t _{su} | Data setup time, (see Figure 1) | 20 | | | 20 | | | ns |
| t _h | Hold time | Data, high or low | | | 0 | | | ns |
| | | LOAD | | | 3 | | | |
| T _A | Operating free-air temperature | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | SN54192 SN54193 | | | SN74192 SN74193 | | | UNIT | |
|-----------------|--|---|------|-----|--------------------|---------|------|---------|----|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | | |
| V _{IH} | High-level input voltage | | 2 | | | 2 | | V | |
| V _{IL} | Low-level input voltage | | | 0.8 | | | 0.8 | V | |
| V _{IK} | Input clamp voltage | V _{CC} = MIN, I _I = -12 mA | | | | | -1.5 | V | |
| V _{OH} | High-level output voltage | V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OH} = -0.4 mA | | | 2.4 | 3.4 | | 2.4 3.4 | V |
| V _{OL} | Low-level output voltage | V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = 0.8 V, I _{OL} = 16 mA | | | | 0.2 0.4 | | 0.2 0.4 | V |
| I _I | Input current at maximum input voltage | V _{CC} = MAX, V _I = 5.5 V | | | | | 1 | 1 | mA |
| I _{IH} | High-level input current | V _{CC} = MAX, V _I = 2.4 V | | | | | 40 | 40 | μA |
| I _{IL} | Low-level input current | V _{CC} = MAX, V _I = 0.4 V | | | | | -1.6 | -1.6 | mA |
| I _{OS} | Short-circuit output current§ | V _{CC} = MAX | | | -20 | | -65 | -18 -65 | mA |
| I _{CC} | Supply current | V _{CC} = MAX, See Note 2 | | | | 65 89 | | 65 102 | mA |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time.

NOTE 2: I_{CC} is measured with all outputs open, clear and load inputs grounded, and all other inputs at 4.5 V.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

| PARAMETER¶ | FROM INPUT | TO OUTPUT | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|-------------------|-----------------|---|-----|-----|-----|------|
| f _{max} | | | C _L = 15 pF, R _L = 400 Ω, See Figures 1 and 2 | 25 | 32 | | MHz |
| t _{PLH} | UP | \overline{CO} | | | 17 | 26 | ns |
| t _{PHL} | | | | | 16 | 24 | |
| t _{PLH} | DOWN | \overline{BO} | | | 16 | 24 | ns |
| t _{PHL} | | | | | 16 | 24 | |
| t _{PLH} | UP OR DOWN | Q | | | 25 | 38 | ns |
| t _{PHL} | | | | | 31 | 47 | |
| t _{PLH} | \overline{LOAD} | Q | | | 27 | 40 | ns |
| t _{PHL} | | | | | 29 | 40 | |
| t _{PHL} | CLR | Q | | | 22 | 35 | ns |

¶ f_{max} ≡ maximum clock frequency

t_{PLH} ≡ propagation delay time, low-to-high-level output

t_{PHL} ≡ propagation delay time, high-to-low-level output



SN54LS192, SN54LS193, SN74LS192, SN74LS193 SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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recommended operating conditions

| | | SN54LS192 SN54LS193 | | | SN74LS192 SN74LS193 | | | UNIT |
|--------------------|--------------------------------------|------------------------|-----|------|------------------------|-----|------|------|
| | | MIN | NOM | MAX | MIN | NOM | MAX | |
| V _{CC} | Supply voltage | 4.5 | 5 | 5.5 | 4.75 | 5 | 5.25 | V |
| I _{OH} | High-level output current | | | -400 | | | -400 | μA |
| I _{OL} | Low-level output current | | | 4 | | | 8 | mA |
| f _{clock} | Clock frequency | 0 | | 25 | 0 | | 25 | MHz |
| t _w | Width of any input pulse | 20 | | | 20 | | | ns |
| t _{su} | Clear inactive-state setup time | 15 | | | 15 | | | ns |
| | Load inactive-state setup time | 15 | | | 15 | | | ns |
| | Data setup time (see Figure 1) | 20 | | | 20 | | | ns |
| t _h | Data hold time | 5 | | | 5 | | | ns |
| T _A | Operating free-air temperature range | -55 | | 125 | 0 | | 70 | °C |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS† | SN54LS192 SN54LS193 | | | SN74LS192 SN74LS193 | | | UNIT | |
|-----------------|--|---|------|------------------------|------------------------|------|------|------|---|
| | | MIN | TYP‡ | MAX | MIN | TYP‡ | MAX | | |
| V _{IH} | High-level input voltage | 2 | | | 2 | | | V | |
| V _{IL} | Low-level input voltage | | | 0.7 | | | 0.8 | V | |
| V _{IK} | Input clamp voltage | V _{CC} = MIN, I _I = -18 mA | | -1.5 | | | -1.5 | V | |
| V _{OH} | High-level output voltage | V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = V _{IL max} , I _{OH} = -400 μA | | 2.5 | 3.4 | | 2.7 | 3.4 | V |
| V _{OL} | Low-level output voltage | V _{CC} = MIN, V _{IH} = 2 V, V _{IL} = V _{IL max} | | I _{OL} = 4 mA | 0.25 | 0.4 | 0.15 | 0.4 | V |
| | | I _{OL} = 8 mA | | | 0.35 | 0.5 | | | |
| I _I | Input current at maximum input voltage | V _{CC} = MAX, V _I = 7 V | | 0.1 | | 0.1 | | mA | |
| I _{IH} | High-level input current | V _{CC} = MAX, V _I = 2.7 V | | 20 | | 20 | | μA | |
| I _{IL} | Low-level input current | V _{CC} = MAX, V _I = 0.4 V | | -0.4 | | -0.4 | | mA | |
| I _{OS} | Short-circuit output current§ | V _{CC} = MAX | | -20 | -100 | -20 | -100 | mA | |
| I _{CC} | Supply current | V _{CC} = MAX, See Note 2 | | 19 | 34 | 19 | 34 | mA | |

† For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type.

‡ All typical values are at V_{CC} = 5 V, T_A = 25°C.

§ Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: I_{CC} is measured with all outputs open, clear and load inputs grounded, and all other inputs at 4.5 V.

switching characteristics, V_{CC} = 5 V, T_A = 25°C

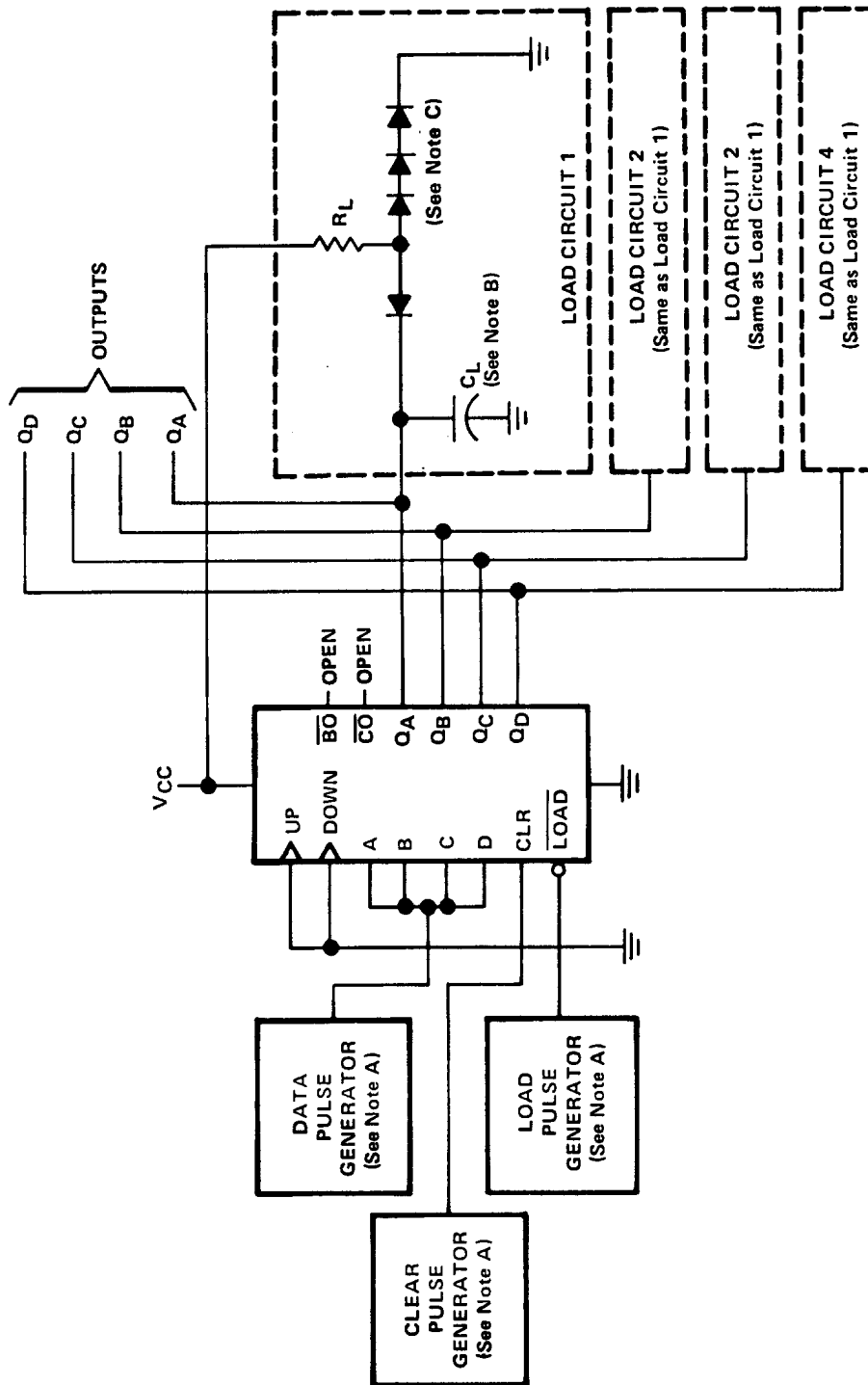
| PARAMETER | FROM INPUT | TO OUTPUT | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|------------------|-------------------|-----------------|--|-----|-----|-----|------|
| f _{max} | | | C _L = 15 pF, R _L = 2 kΩ, See Figures 1 and 2 | 25 | 32 | | MHz |
| t _{PLH} | UP | \overline{CO} | | | 17 | 26 | ns |
| t _{PHL} | | | | | 18 | 24 | |
| t _{PLH} | DOWN | \overline{BO} | | | 16 | 24 | ns |
| t _{PHL} | | | | | 15 | 24 | |
| t _{PLH} | UP OR DOWN | Q | | | 27 | 38 | ns |
| t _{PHL} | | | | | 30 | 47 | |
| t _{PLH} | \overline{LOAD} | Q | | | 24 | 40 | ns |
| t _{PHL} | | | | | 25 | 40 | |
| t _{PHL} | CLR | Q | | | 23 | 35 | ns |



SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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PARAMETER MEASUREMENT INFORMATION



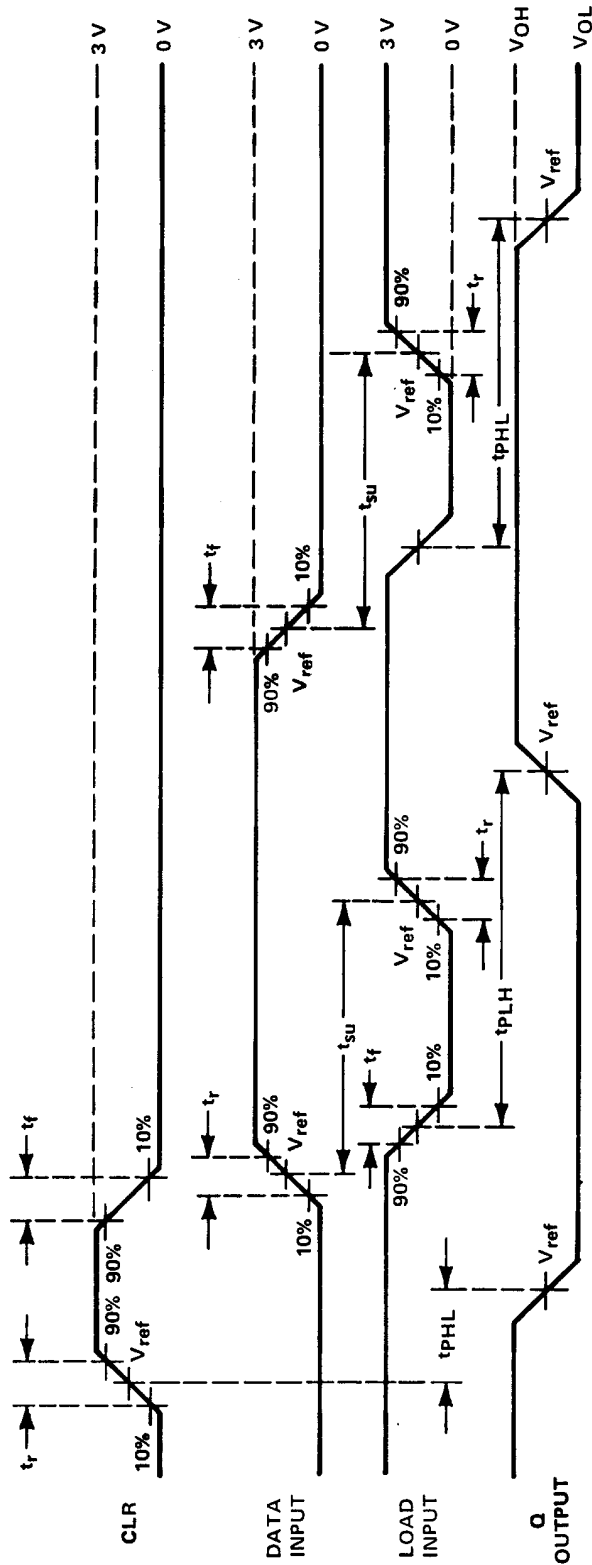
TEST CIRCUIT

- NOTES: A. The pulse generators have the following characteristics: $Z_{out} \approx 50 \Omega$ and for the data pulse generator $PRR \leq 500 \text{ kHz}$, duty cycle = 50%; for the load pulse generator PRR is two times data PRR , duty cycle = 50%.
- B. C_L includes probe and jig capacitance.
- C. Diodes are 1N3064 or equivalent.
- D. t_r and $t_f \leq 7 \text{ ns}$.
- E. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 1A - CLEAR, SETUP AND LOAD TIMES

**SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)**
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PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

- NOTES:**
- A. The pulse generators have the following characteristics: $Z_{out} \approx 50 \Omega$ and for the data pulse generator PRR ≤ 500 kHz, duty cycle = 50%; for the load pulse generator PRR is two times data PRR, duty cycle = 50%
 - B. C_L includes probe and jig capacitance.
 - C. Diodes are 1N3064 or equivalent.
 - D. t_r and $t_f \leq 7$ ns.
 - E. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 1B - CLEAR, SETUP, AND LOAD TIMES

**SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193**
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)

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PARAMETER MEASUREMENT INFORMATION



TEST CIRCUIT

- NOTES:**
- A. The pulse generators have the following characteristics: PRR \approx 1 MHz, $Z_{out} \approx$ 50 Ω , duty cycle = 50%.
 - B. C_L includes probe and jig capacitance.
 - C. Diodes are 1N3064 or equivalent.
 - D. Count-up and count-down pulse shown are for the '193 and 'LS193 binary counters. Count cycle for '192 and 'LS192 decade counters is 1 through 10.
 - E. Waveforms for outputs Q_A , Q_B , and Q_C are omitted to simplify the drawing.
 - F. t_r and $t_f \leq$ 7 ns.
 - G. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 2A - PROPAGATION DELAY TIMES

**SN54192, SN54193, SN54LS192, SN54LS193,
SN74192, SN74193, SN74LS192, SN74LS193
SYNCHRONOUS 4-BIT UP/DOWN COUNTERS (DUAL CLOCK WITH CLEAR)**

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PARAMETER MEASUREMENT INFORMATION



VOLTAGE WAVEFORMS

- NOTES: A. The pulse generators have the following characteristics: PRR \approx 1 MHz, $Z_{out} \approx 50 \Omega$, duty cycle = 50%.
 B. C_L includes probe and jig capacitance.
 C. Diodes are 1N3064 or equivalent.
 D. Count-up and count-down pulse shown are for the '193 and 'LS193 binary counters. Count cycle for '192 and 'LS192 decade counters is 1 through 10.
 E. Waveforms for outputs Q_A , Q_B , and Q_C are omitted to simplify the drawing.
 F. t_r and $t_f \leq 7$ ns.
 G. V_{ref} is 1.5 V for '192 and '193, 1.3 V for 'LS192 and 'LS193.

FIGURE 2B - PROPAGATION DELAY TIMES

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|----------------------|------------------------------|-----------------------------|
| 5962-9558401QEA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Call TI | |
| 5962-9558401QFA | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Call TI | |
| 5962-9558401QFA | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Call TI | |
| 76006012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Call TI | |
| 76006012A | ACTIVE | LCCC | FK | 20 | 1 | TBD | Call TI | Call TI | |
| 7600601EA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Call TI | |
| 7600601EA | ACTIVE | CDIP | J | 16 | 1 | TBD | Call TI | Call TI | |
| 7600601FA | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Call TI | |
| 7600601FA | ACTIVE | CFP | W | 16 | 1 | TBD | Call TI | Call TI | |
| JM38510/01309BEA | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| JM38510/01309BEA | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| JM38510/31508B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| JM38510/31508B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| JM38510/31508BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508BFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508BFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508SEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508SEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508SFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| JM38510/31508SFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| M38510/31508B2A | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| M38510/31508BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508BEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508BFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508BFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508SEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508SEA | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| M38510/31508SFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|----------------------------|----------------------|------------------------------|-----------------------------|
| M38510/31508SFA | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SN54192J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SN54192J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SN54193J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| SN54193J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| SN54LS193J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SN54LS193J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SN74192N | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74192N | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74193N | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74193N | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74193N3 | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74193N3 | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74LS192D | OBSOLETE | SOIC | D | 16 | | TBD | Call TI | Call TI | |
| SN74LS192D | OBSOLETE | SOIC | D | 16 | | TBD | Call TI | Call TI | |
| SN74LS192N | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74LS192N | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74LS193D | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193D | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DE4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DG4 | ACTIVE | SOIC | D | 16 | 40 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DR | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|----------------------|------------------------------|-----------------------------|
| SN74LS193DRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DRE4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DRG4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193DRG4 | ACTIVE | SOIC | D | 16 | 2500 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| SN74LS193J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| SN74LS193N | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74LS193N | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74LS193N3 | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74LS193N3 | OBSOLETE | PDIP | N | 16 | | TBD | Call TI | Call TI | |
| SN74LS193NE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74LS193NE4 | ACTIVE | PDIP | N | 16 | 25 | Pb-Free (RoHS) | CU NIPDAU | N / A for Pkg Type | |
| SN74LS193NSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193NSR | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193NSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193NSRE4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193NSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SN74LS193NSRG4 | ACTIVE | SO | NS | 16 | 2000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM | |
| SNJ54192J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54192J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54192W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54192W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54193J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |
| SNJ54193J | OBSOLETE | CDIP | J | 16 | | TBD | Call TI | Call TI | |

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | Eco Plan ⁽²⁾ | Lead/ Ball Finish | MSL Peak Temp ⁽³⁾ | Samples (Requires Login) |
|------------------|-----------------------|--------------|-----------------|------|-------------|-------------------------|----------------------|------------------------------|-----------------------------|
| SNJ54193W | OBSOLETE | CFP | W | 16 | | TBD | Call TI | Call TI | |
| SNJ54193W | OBSOLETE | CFP | W | 16 | | TBD | Call TI | Call TI | |
| SNJ54LS193FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| SNJ54LS193FK | ACTIVE | LCCC | FK | 20 | 1 | TBD | POST-PLATE | N / A for Pkg Type | |
| SNJ54LS193J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54LS193J | ACTIVE | CDIP | J | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54LS193W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |
| SNJ54LS193W | ACTIVE | CFP | W | 16 | 1 | TBD | A42 | N / A for Pkg Type | |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

⁽³⁾ MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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OTHER QUALIFIED VERSIONS OF SN54192, SN54193, SN54LS193, SN54LS193-SP, SN74192, SN74193, SN74LS193 :

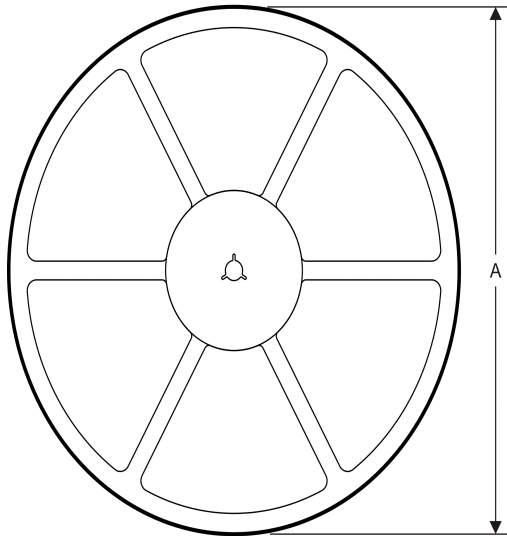
- Catalog: [SN74192](#), [SN74193](#), [SN74LS193](#), [SN54LS193](#)
- Military: [SN54192](#), [SN54193](#), [SN54LS193](#)
- Space: [SN54LS193-SP](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications
- Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

TAPE AND REEL INFORMATION

REEL DIMENSIONS



TAPE DIMENSIONS



| | |
|----|---|
| A0 | Dimension designed to accommodate the component width |
| B0 | Dimension designed to accommodate the component length |
| K0 | Dimension designed to accommodate the component thickness |
| W | Overall width of the carrier tape |
| P1 | Pitch between successive cavity centers |

TAPE AND REEL INFORMATION

*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|--------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| SN74LS193DR | SOIC | D | 16 | 2500 | 330.0 | 16.4 | 6.5 | 10.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LS193NSR | SO | NS | 16 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |

TAPE AND REEL BOX DIMENSIONS


*All dimensions are nominal

| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|--------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LS193DR | SOIC | D | 16 | 2500 | 333.2 | 345.9 | 28.6 |
| SN74LS193NSR | SO | NS | 16 | 2000 | 346.0 | 346.0 | 33.0 |

J (R-GDIP-T**)

14 LEADS SHOWN

CERAMIC DUAL IN-LINE PACKAGE



| DIM \ PINS ** | 14 | 16 | 18 | 20 |
|---------------|------------------------|------------------------|------------------------|------------------------|
| A | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC | 0.300 (7,62) BSC |
| B MAX | 0.785 (19,94) | .840 (21,34) | 0.960 (24,38) | 1.060 (26,92) |
| B MIN | — | — | — | — |
| C MAX | 0.300 (7,62) | 0.300 (7,62) | 0.310 (7,87) | 0.300 (7,62) |
| C MIN | 0.245 (6,22) | 0.245 (6,22) | 0.220 (5,59) | 0.245 (6,22) |



4040083/F 03/03

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package is hermetically sealed with a ceramic lid using glass frit.
 - Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
 - Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

W (R-GDFP-F16)

CERAMIC DUAL FLATPACK



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - C. This package can be hermetically sealed with a ceramic lid using glass frit.
 - D. Index point is provided on cap for terminal identification only.
 - E. Falls within MIL STD 1835 GDFP1-F16 and JEDEC MO-092AC

FK (S-CQCC-N**)

LEADLESS CERAMIC CHIP CARRIER

28 TERMINAL SHOWN



| NO. OF TERMINALS ** | A | | B | |
|---------------------|------------------|------------------|------------------|------------------|
| | MIN | MAX | MIN | MAX |
| 20 | 0.342 (8,69) | 0.358 (9,09) | 0.307 (7,80) | 0.358 (9,09) |
| 28 | 0.442 (11,23) | 0.458 (11,63) | 0.406 (10,31) | 0.458 (11,63) |
| 44 | 0.640 (16,26) | 0.660 (16,76) | 0.495 (12,58) | 0.560 (14,22) |
| 52 | 0.740 (18,78) | 0.761 (19,32) | 0.495 (12,58) | 0.560 (14,22) |
| 68 | 0.938 (23,83) | 0.962 (24,43) | 0.850 (21,6) | 0.858 (21,8) |
| 84 | 1.141 (28,99) | 1.165 (29,59) | 1.047 (26,6) | 1.063 (27,0) |



4040140/D 01/11

- NOTES:
- All linear dimensions are in inches (millimeters).
 - This drawing is subject to change without notice.
 - This package can be hermetically sealed with a metal lid.
 - Falls within JEDEC MS-004

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

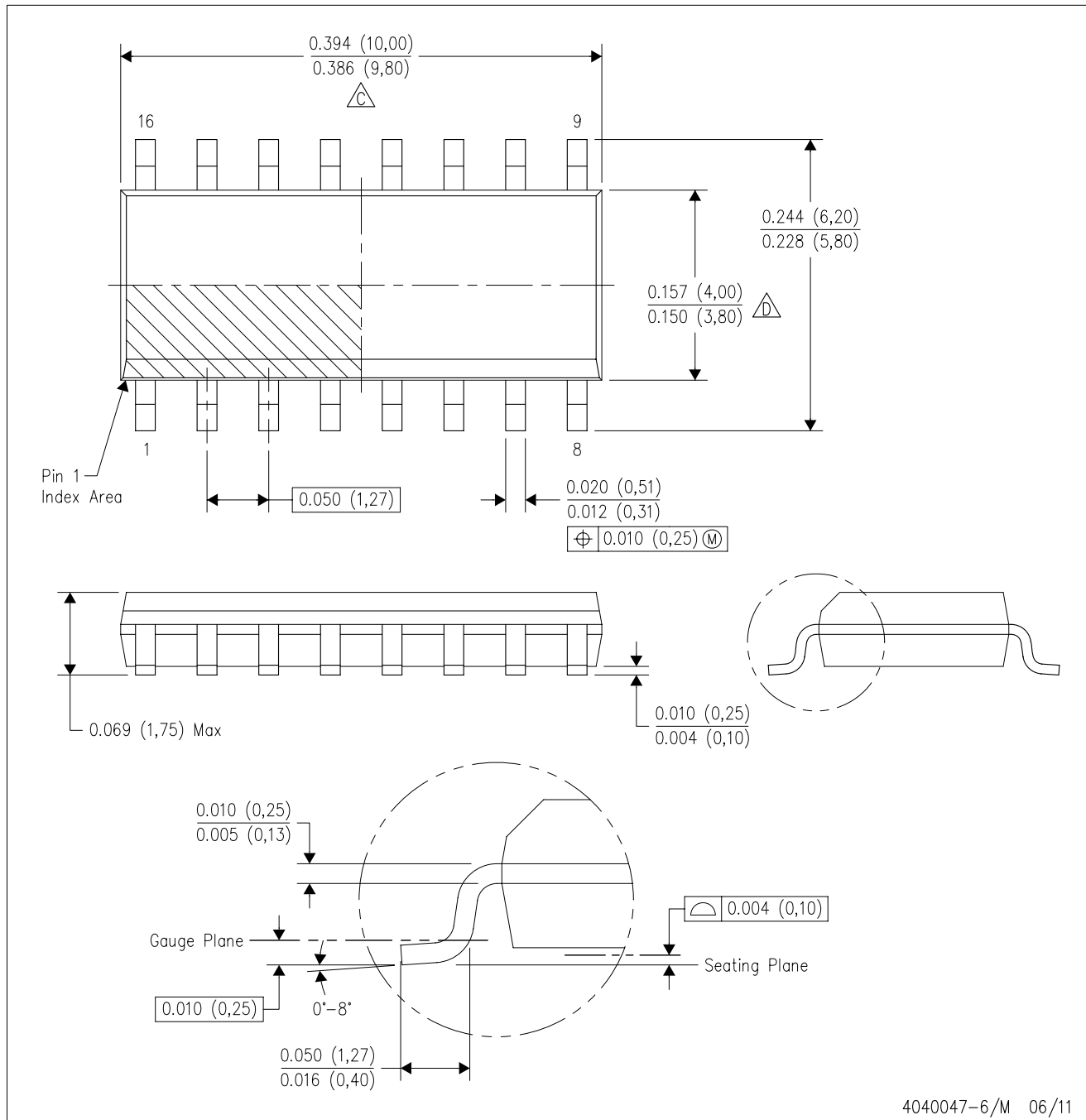
16 PINS SHOWN



- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 - $\triangle C$ Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
 - $\triangle D$ The 20 pin end lead shoulder width is a vendor option, either half or full width.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE

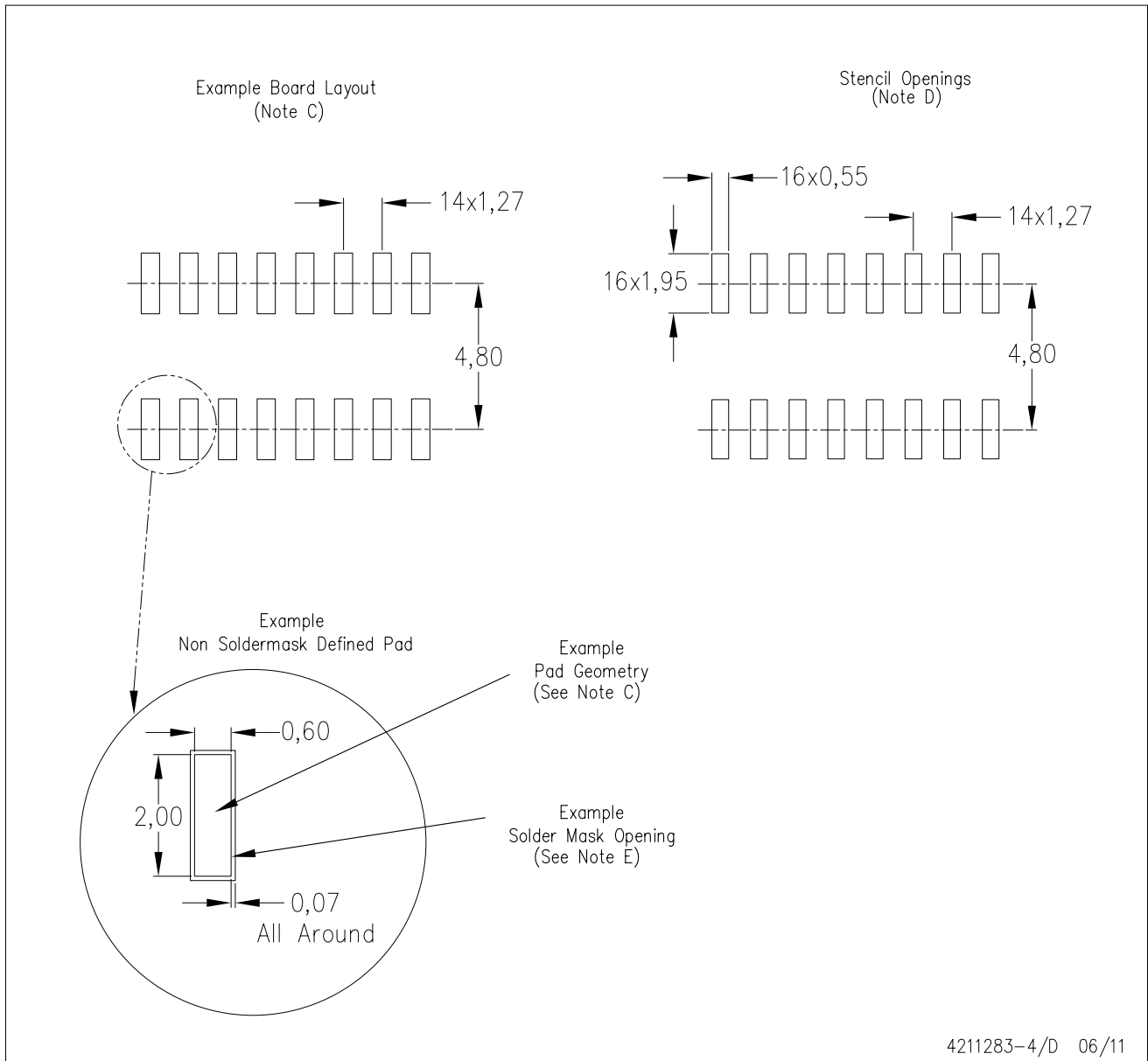


4040047-6/M 06/11

- NOTES:
- A. All linear dimensions are in inches (millimeters).
 - B. This drawing is subject to change without notice.
 -  Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
 -  Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
 - E. Reference JEDEC MS-012 variation AC.

D (R-PDSO-G16)

PLASTIC SMALL OUTLINE



- NOTES:
- All linear dimensions are in millimeters.
 - This drawing is subject to change without notice.
 - Publication IPC-7351 is recommended for alternate designs.
 - Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC-7525 for other stencil recommendations.
 - Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.

MECHANICAL DATA

NS (R-PDSO-G**)

PLASTIC SMALL-OUTLINE PACKAGE

14-PINS SHOWN



- NOTES:
- A. All linear dimensions are in millimeters.
 - B. This drawing is subject to change without notice.
 - C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.

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